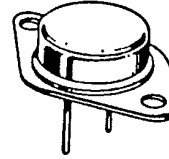


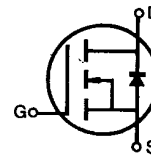
IRF330/331/332/333**N-CHANNEL
POWER MOSFETS****FEATURES**

- Low $R_{DS(on)}$
- Improved inductive ruggedness
- Fast switching times
- Rugged polysilicon gate cell structure
- Low input capacitance
- Extended safe operating area
- Improved high temperature reliability
- TO-3 package (Standard)

TO-3

**PRODUCT SUMMARY**

Part Number	V_{DS}	$R_{DS(on)}$	I_D
IRF330	400V	1.0 Ω	5.5A
IRF331	350V	1.0 Ω	5.5A
IRF332	400V	1.5 Ω	4.5A
IRF333	350V	1.5 Ω	4.5A

**MAXIMUM RATINGS**

Characteristic	Symbol	IRF330	IRF331	IRF332	IRF333	Unit
Drain-Source Voltage (1)	V_{DSS}	400	350	400	350	Vdc
Drain-Gate Voltage ($R_{GS}=1.0M\Omega$)(1)	V_{DGR}	400	350	400	350	Vdc
Gate-Source Voltage	V_{GS}	± 20				Vdc
Continuous Drain Current $T_C=25^\circ C$	I_D	5.5	5.5	4.5	4.5	Adc
Continuous Drain Current $T_C=100^\circ C$	I_D	3.5	3.5	3.0	3.0	Adc
Drain Current—Pulsed (3)	I_{DM}	22	22	18	18	Adc
Gate Current—Pulsed	I_{GM}	± 1.5				Adc
Total Power Dissipation @ $T_C=25^\circ C$ Derate above $25^\circ C$	P_D	75 0.6				Watts W/ $^\circ C$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to 150				$^\circ C$
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T_L	300				$^\circ C$

Notes: (1) $T_J=25^\circ C$ to $150^\circ C$
 (2) Pulse test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$
 (3) Repetitive rating: Pulse width limited by max. junction temperature

IRF330/331/332/333**N-CHANNEL
POWER MOSFETS****ELECTRICAL CHARACTERISTICS** ($T_C=25^\circ\text{C}$ unless otherwise specified)

Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	IRF330 IRF332	400	—	—	V	$V_{GS}=0V$
		IRF331 IRF333	350	—	—	V	$I_D=250\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	ALL	2.0	—	4.0	V	$V_{DS}=V_{GS}$, $I_D=250\mu A$
Gate-Source Leakage Forward	I_{GSS}	ALL	—	—	100	nA	$V_{GS}=20V$
Gate-Source Leakage Reverse	I_{GSS}	ALL	—	—	-100	nA	$V_{GS}=-20V$
Zero Gate Voltage Drain Current	I_{DSS}	ALL	—	—	250	μA	$V_{DS}=\text{Max. Rating}$, $V_{GS}=0V$
			—	—	1000	μA	$V_{DS}=\text{Max. Rating}\times 0.8$, $V_{GS}=0V$, $T_C=125^\circ\text{C}$
On-State Drain-Source Current (2)	$I_{D(on)}$	IRF330 IRF331	5.5	—	—	A	$V_{DS}>I_{D(on)}\times R_{DS(on) \text{ max.}}$, $V_{GS}=10V$
		IRF332 IRF333	4.5	—	—	A	
Static Drain-Source On-State Resistance (2)	$R_{DS(on)}$	IRF330 IRF331	—	0.8	1.0	Ω	$V_{GS}=10V$, $I_D=3.0A$
		IRF332 IRF333	—	1.0	1.5	Ω	
Forward Transconductance (2)	g_{fs}	ALL	3.0	4.4	—	Ω	$V_{DS}>I_{D(on)}\times R_{DS(on) \text{ max.}}$, $I_D=3.0A$
Input Capacitance	C_{iss}	ALL	—	730	900	pF	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0\text{MHz}$
Output Capacitance	C_{oss}	ALL	—	100	300	pF	
Reverse Transfer Capacitance	C_{rss}	ALL	—	50	80	pF	
Turn-On Delay Time	$t_{d(on)}$	ALL	—	—	30	ns	$V_{DD}=0.5BV_{DSS}$, $I_D=3.0A$, $Z_\theta=15\Omega$ (MOSFET switching times are essentially independent of operating temperature.)
Rise Time	t_r	ALL	—	—	35	ns	
Turn-Off Delay Time	$t_{d(off)}$	ALL	—	—	55	ns	
Fall Time	t_f	ALL	—	—	35	ns	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q_g	ALL	—	18	30	nC	$V_{GS}=10V$, $I_D=7.0A$, $V_{DS}=0.8 \text{ Max. Rating}$ (Gate charge is essentially independent of operating temperature.)
Gate-Source Charge	Q_{gs}	ALL	—	4.0	—	nC	
Gate-Drain ("Miller") Charge	Q_{gd}	ALL	—	14	—	nC	

THERMAL RESISTANCE

Junction-to-Case	R_{thJC}	ALL	—	—	1.67	K/W	
Case-to-Sink	R_{thCS}	ALL	—	0.1	—	K/W	Mounting surface flat, smooth, and greased
Junction-to-Ambient	R_{thJA}	ALL	—	—	30	K/W	Free Air Operation

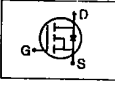
Notes: (1) $T_J=25^\circ\text{C}$ to 150°C (2) Pulse test: Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

(3) Repetitive rating: Pulse width limited by max. junction temperature

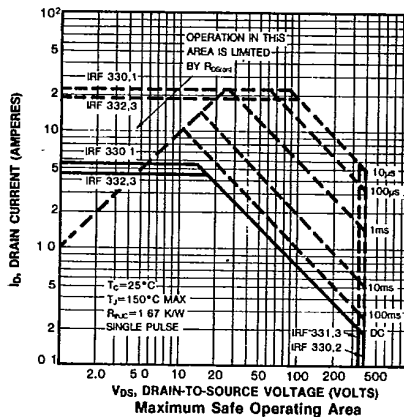
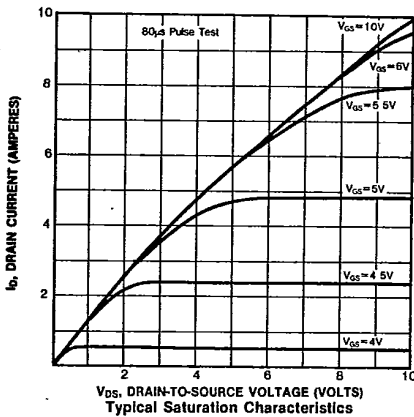
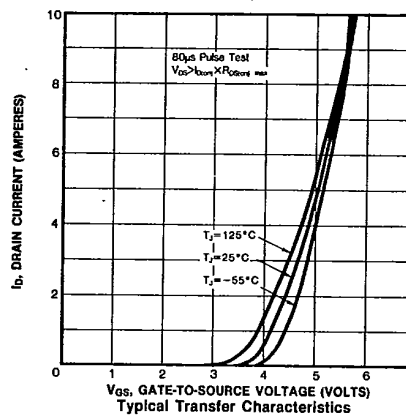
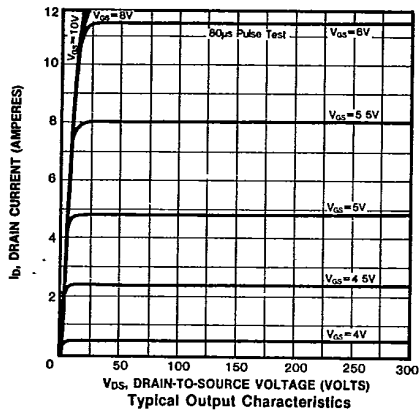
IRF330/331/332/333

**N-CHANNEL
POWER MOSFETS**

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

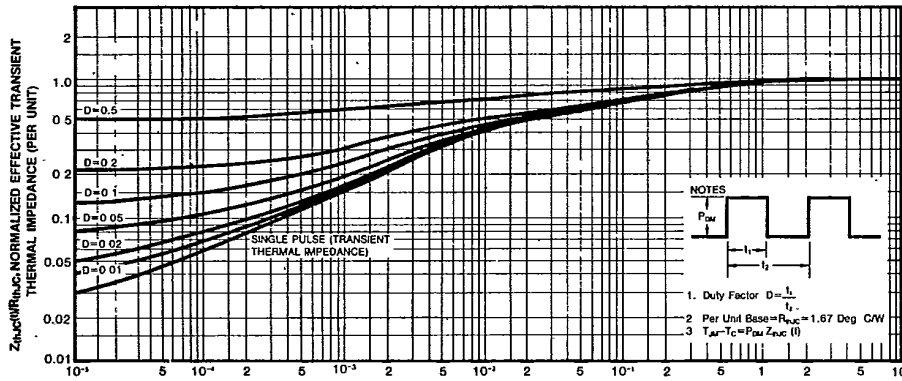
Characteristic	Symbol	Type	Min	Typ	Max	Units	Test Conditions
Continuous Source Current (Body Diode)	I _S	IRF330	—	—	5.5	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier 
		IRF331	—	—	5.5	A	
		IRF332	—	—	4.5	A	
Pulse Source Current (Body Diode) (3)	I _{SM}	IRF330	—	—	22	A	
		IRF331	—	—	22	A	
		IRF332	—	—	18	A	
Diode Forward Voltage (2)	V _{SD}	IRF330	—	—	1.6	V	T _C =25°C, I _S =5.5A, V _{GS} =0V
		IRF331	—	—	1.6	V	T _C =25°C, I _S =5.5A, V _{GS} =0V
		IRF332	—	—	1.5	V	T _C =25°C, I _S =4.5A, V _{GS} =0V
Reverse Recovery Time	t _{rr}	ALL	—	600	—	ns	T _J =150°C, I _F =5.5A, dI _F /dt=100A/μs

Notes: (1) T_J=25°C to 150°C (2) Pulse test: Pulse width≤300μs, Duty Cycle≤2%
(3) Repetitive rating: Pulse width limited by max. junction temperature

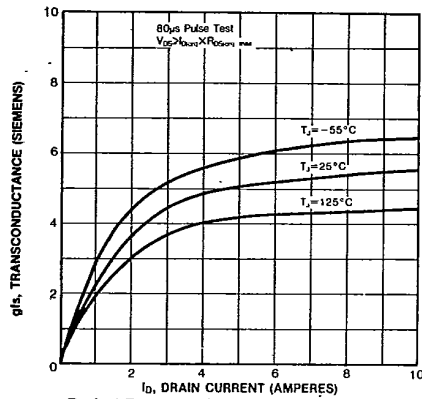


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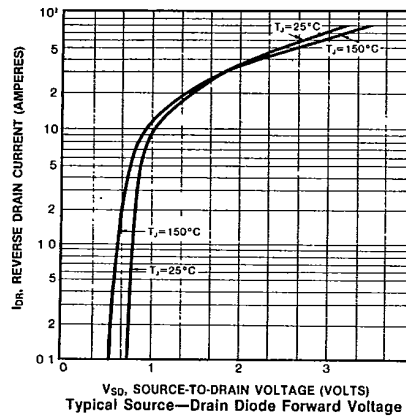
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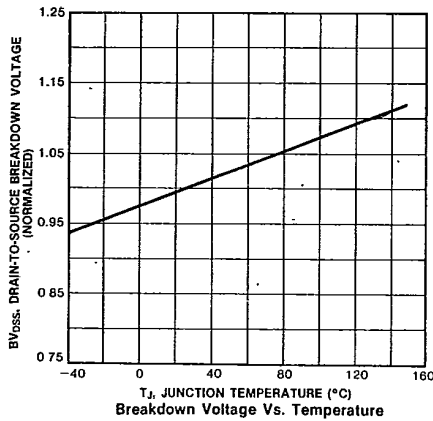
Maximum Effective Transient Thermal Impedance Junction-to-Case Vs. Pulse Duration



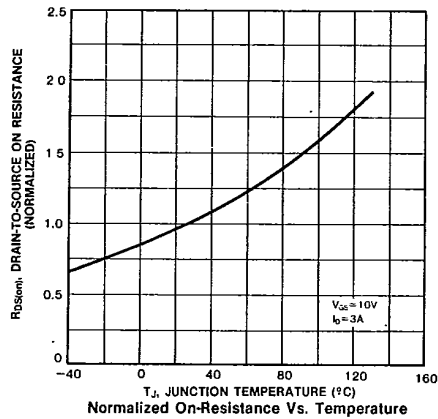
Typical Transconductance Vs. Drain Current



Typical Source-Drain Diode Forward Voltage



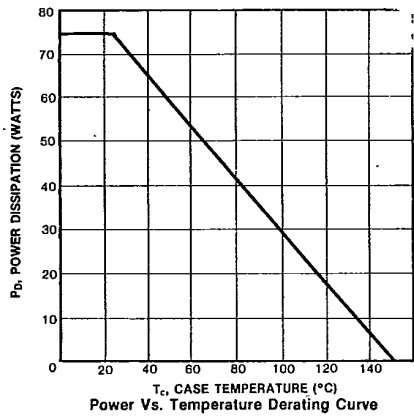
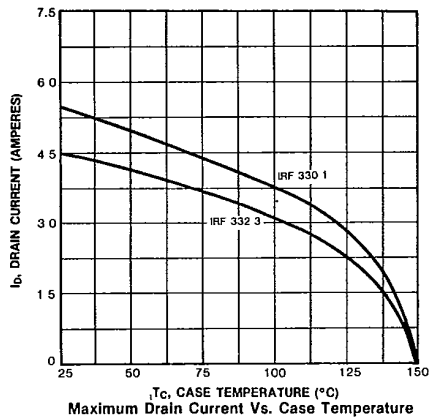
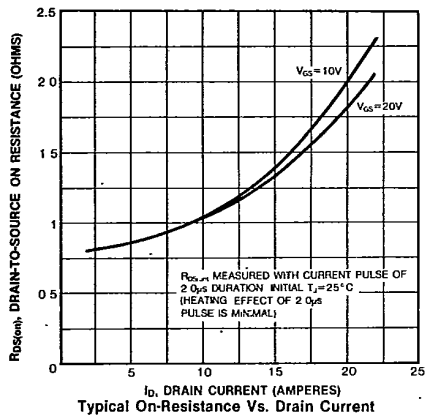
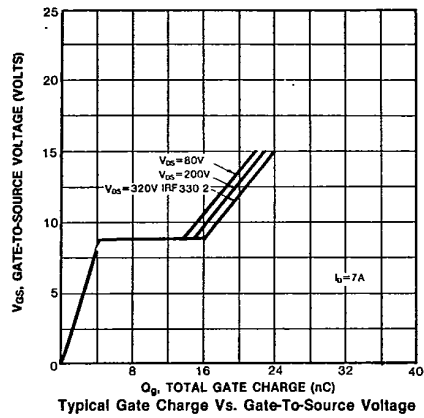
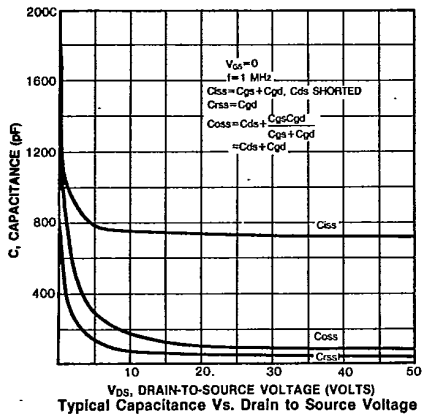
Breakdown Voltage Vs. Temperature



Normalized On-Resistance Vs. Temperature

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